EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S4	645237	implant$ or dop$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:32
S5	8320636	(viahole or opening or aperture or trench or hole or via)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:39
S6	1430862	hydrogen or h2 or "h.sub.2"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:41
S8	15115	S4 with S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/21 14:26
S9	721	S8 with S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/21 14:29
S10	540	S9 and @ad< "20030401"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:11
S14	3021723	ch3 or "ch.sub.3" or ch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/22 08:42
S15	2233314	dielectric or insulat$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:43
S16	9880	S14 with S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:43
S17	516	S16 with (treat$4 or expos$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 08:45
S18	153	S17 and @ad< "20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:42

S19	2	"6790774".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 10:05
S20	3	(("20020022365") or ("6538324") or ("6333248")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 10:08
S21	4	(("20020022365") or ("6645852") or ("6538324") or ("6333248")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 11:00
S22	11	(("20050095751") or ("20050054195") or ("20040166676") or ("20030194857") or ("20030104692") or ("20010053592") or ("6861349") or ("6833321") or ("6703307") or ("6642146") or ("5990011")).PN.	US-PGPUB; USPAT	OR	OFF	2006/02/22 13:14
S23	6190	implant$7 with barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:38
S24	1637	S23 and (copper or tungsten or cu)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:38
S25	1329	S24 and (damascene or viahole or opening or aperture or trench or hole or via)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:40
S26	136	S24 and (damascene)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:39
S27	635	S25 and (stop$4 or etchstop$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:40
S28	1430862	hydrogen or h2 or "h.sub.2"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:42
S29	307	S27 and S28	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 11:55
S30	192	S29 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/22 12:26
S32	32	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:27

S33	2	("6318124").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:52
S34	2	("5554570").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/21 09:52
S35	2	"770114".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:43
S36	2	"20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/21 14:43
S37	411	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) near4 (dielectric near3 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:22
S38	683	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) with (porous or nonporous)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:37
S39	68	(hsq or hydrogensilsesquioxane or (hydrogen adj1 silsesquioxane)) with (hybrid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 08:38
S40	0	S39 and "20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:08
S41	29196	supercritical or (super adj1 critical)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09
S42	2	("6318124").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09
S43	2	"20010019857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:09
S44	4	S42 or S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:09

S45	0	S44 and S41	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:10
S46	32	10/682196 and S41	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:13
S47	393881	"co.sub.2" or (carbon adj1 dioxide) or (carbon adj1 di-oxide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:14
S48	10763	S41 with S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/23 10:14
S49	1826013	semiconductor or (semi adj1 conductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:15
S50	1908	S48 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:15
S51	717	(dielectric or insulat$4 or film or layer) with S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:16
S52	394	S51 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 10:16
S53	229	S52 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/25 06:47
S54	0	(11/009575).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 06:48
S55	1	11/009575	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:20
S56	1	10/195527	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:27

S57	1	10/976376	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:30
S58	2	"6746591"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/25 20:33
S59	1	11/096515	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 07:55
S60	6	"6274429"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 09:40
S61	1	10/976376	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/27 09:40
S62	2	"5679606".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 08:56
S63	2	"6033981".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:14
S64	1	10/784186	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:15
S65	1	S64 and situ	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/07/26 09:15
S66	1069	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 15:13
S68	5	10/682196 and S66	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 15:13
S69	7338	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2008/02/13 15:20

S70	7712	S66 or S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:21
S71	1540	S70 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:21
S72	912	S71 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:22
S73	1	11/175582	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:39
S74	2	"5440161".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 15:47
S75	1069	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/13 22:06
S76	7338	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S77	7712	S75 or S76	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S78	1540	S77 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S79	912	S78 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S80	652	S79 AND (OPENING OR VIA OR HOLE OR VIAHOLE OR APERTURE OR TRENCH)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/13 22:06
S81	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 15:13

S82	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:13
S83	7719	S81 or S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:13
S84	521	S83 with (n2 or nitrogen or cl2 or chlori$4 or "n.sub.2" or "cl.sub.2")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:14
S85	385	S84 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 15:15
S86	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 21:38
S87	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S88	7719	S86 or S87	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S89	521	S88 with (n2 or nitrogen or cl2 or chlori$4 or "n.sub.2" or "cl.sub.2")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S90	385	S89 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S91	86	S90 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 21:38
S92	385	S89 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S93	1071	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/02/14 23:36

S94	7345	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S95	7719	S93 or S94	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S96	1544	S95 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S97	912	S96 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S98	652	S97 AND (OPENING OR VIA OR HOLE OR VIAHOLE OR APERTURE OR TRENCH)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/02/14 23:36
S99	49	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 09:59
S100	35	S99 and plasma$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 10:11
S101	8	S99 and (tmcts or omcts)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 10:21
S102	2	("20030089988").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 10:55
S104	8137	TMCTS or tetramethylcyclotetrasiloxane or OMCTS or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 11:03
S105	5240	S104 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 11:05
S106	919	S105 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 11:06

S107	636	S104 with (treat$5 or expos$4 or wash$4 or clean$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:28
S108	109	S107 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S109	109	S108 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S110	55	S108 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 13:29
S111	222693	sic or (silicon adj1 (carbon or carbide))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:51
S112	216	S104 same S111	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:52
S113	96	S112 and @ad<"20031010"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 14:59
S114	59	S113 and (semiconductor or (semi adj1 conductor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 15:00
S115	2	"20030089988".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 15:55
S116	4	(("6318124") or ("20010019857")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 16:00
S119	21095	((257/328-334) or (257/296-310) or (438/257-267)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:50
S120	881664	isolation or fox or sti or (field near1 oxide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:53

S121	11245	S119 and S120	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/22 23:54
S122	3513	S121 and ((gate or electrode) near2 ((trench or opening or via or viahole or aperture))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 23:55
S123	3181	S122 and @ad< "20060609"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/22 23:55
S124	1	11/450096	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/23 15:29
S125	1	11/143025	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/23 15:39
S126	2	("20040087078").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/23 15:56
S127	2	("6930299").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/23 21:34
S128	2	("6660587").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:32
S129	191	(US-20040166676-$ or US-20060006548-$ or US-20060024849-$ or US-20050029117-$ or US-20030211312-$ or US-20040041267-$ or US-20020098684-$ or US-20050010000-$ or US-20020015800-$ or US-20040053459-$ or US-20040046190-$ or US-20040043597-$ or US-20040137756-$ or US-20010019857-$ or US-20030118796-$ or US-20020018152-$ or US-20050077597-$ or US-20050215072-$ or US-20020055275-$ or US-20020187627-$ or US-20020140003-$ or US-20050032352-$ or US-20040166445-$ or US-20040053498-$ or US-20040099952-$ or US-20040224865-$).did. or (US-20040185656-$ or US-20040180299-$ or US-20040176488-$ or US-20040175958-$ or US-20040134885-$ or US-20040118812-$ or US-20040018452-$ or US-20020020946-$ or US-20040038155-$ or US-20030236003-$ or US-	US-PGPUB; USPAT; DERWENT	OR	OFF	2009/01/22 14:42

20030040192-$ or US-20060110610-$ or
US-20060040110-$ or US-20050064698-$
or US-20050059245-$ or US-
20050048772-$ or US-20050048731-$ or
US-20050037153-$ or US-20040253378-$
or US-20040241342-$ or US-
20040175929-$ or US-20040152338-$ or
US-20040132287-$ or US-20040101633-$
or US-20040083964-$ or US-
20040082199-$ or US-20040067308-$).
did. or (US-20040061176-$ or US-
20040018735-$ or US-20030211244-$ or
US-20030176058-$ or US-20030162410-$
or US-20030113995-$ or US-
20030109136-$ or US-20030104708-$ or
US-20030089988-$ or US-20030054667-$
or US-20030042605-$ or US-
20030003768-$ or US-20030001282-$ or
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or US-20040082193-$ or US-
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US-20030116421-$ or US-20030059628-$
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or US-20040102006-$ or US-
20040069410-$).did. or (US-
20030232495-$ or US-20030194496-$ or
US-20030149213-$ or US-20030144420-$
or US-20030143865-$ or US-
20030124785-$ or US-20030077916-$ or
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or US-20040078152-$ or US-
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US-20070238249-$ or US-20070221976-$
or US-20070138523-$ or US-
20070085123-$ or US-20070082444-$ or
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or US-20070040201-$ or US-
20070012992-$ or US-20060237783-$ or
US-20060197132-$ or US-20050247966-$
or US-20040195608-$ or US-
20010025973-$).did. or (US-6423639-$ or
US-5258329-$ or US-6537896-$ or US-
6624087-$ or US-6777322-$ or US-
6831370-$ or US-6613399-$ or US-
6624075-$ or US-6630741-$ or US-
6479407-$ or US-6555450-$ or US-
6025273-$ or US-6717236-$ or US-
6703273-$ or US-6690071-$ or US-
6673721-$ or US-6218206-$ or US-
6660633-$ or US-6642620-$ or US-
6515368-$ or US-4956314-$ or US-
6831018-$ or US-6713382-$ or US-
6171951-$ or US-6638850-$ or US-
6638848-$).did. or (US-6998343-$ or US-
6632738-$ or US-6674170-$ or US-
6924222-$ or US-7056837-$ or US-
6565764-$ or US-6524429-$ or US-
6943104-$ or US-6939800-$ or US-
6485815-$ or US-7105460-$ or US-
7060330-$ or US-6913992-$ or US-
6890850-$ or US-6806203-$ or US-
6797643-$ or US-6784119-$ or US-
6737746-$ or US-6657304-$ or US-

		6541842-$ or US-6465345-$ or US-5990557-$ or US-5691573-$ or US-6890605-$ or US-6884318-$ or US-6870123-$ or US-6770570-$).did. or (US-6749944-$ or US-6677549-$ or US-6378337-$ or US-5869406-$ or US-5593741-$ or US-5290736-$ or US-5231058-$ or US-7345000-$ or US-6100181-$ or US-6759327-$ or US-6627532-$ or US-7425740-$ or US-7414278-$ or US-7358556-$ or US-7309890-$ or US-7250342-$ or US-7211864-$ or US-7157763-$ or US-7094644-$ or US-7087956-$ or US-7084457-$ or US-7045846-$ or US-7030440-$ or US-6995415-$ or US-6727539-$ or US-6177697-$).did. or (KR-9502955-$ or US-6391658-$ or US-6291295-$ or TW-441002-$ or JP-2000164704-$ or US-20040175958-$).did.				
S130	51	10/682196	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:45
S131	12	S130 and (cl or "cl.sub.2" or chlori$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:47
S132	3558524	(cl or "cl.sub.2" or chlori$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:52
S133	1248	tmcts or omcts	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:54
S134	8065	tetramethylcyclotetrasiloxane or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:54
S135	8474	S133 or S134	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/22 14:54
S136	8467	TMCTS or tetramethylcyclotetrasiloxane or OMCTS or octamethylcyclotetrasiloxane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:55
S137	5275	S136 and S132	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/22 14:56

| S138 | 3115 | S137 and @ad< "20031010" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/01/22 14:56 |
| S139 | 387 | S138 and (semiconductor or (semi adj1 conductor)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/01/22 14:57 |

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